

DGD2181

### HIGH-SIDE AND LOW-SIDE GATE DRIVER IN SO-8

### **Description**

The DGD2181 is a high voltage / high speed gate driver capable of driving N-Channel MOSFETs and IGBTs in a half bridge configuration. High voltage processing techniques enable the DGD2181's high-side to switch to 600V in a bootstrap operation.

The DGD2181 logic inputs are compatible with standard TTL and CMOS levels (down to 3.3V) for easy interfacing with controlling devices. The driver outputs feature high pulse current buffers designed for minimum driver cross conduction.

The DGD2181 is offered in SO-8 package and the operating temperature extends from -40°C to +125°C.

### **Applications**

- DC-DC Converters
- DC-AC Inverters
- AC-DC Power Supplies
- Motor Controls
- Class D Power Amplifiers

# V<sub>CC</sub> V<sub>CC</sub> V<sub>B</sub> HIN DGD2181 V<sub>S</sub> COM LO

### **Features**

- Floating High-side Driver in Bootstrap Operation to 600V
- Drives Two N-Channel MOSFETs or IGBTs in a Half Bridge Configuration
- 1.9A Source / 2.3A Sink Output Current Capability
- Outputs Tolerant to Negative Transients
- Wide Low-side Gate Driver and Logic Supply: 10V to 20V
- Logic Input (HIN and LIN) 3.3V Capability
- Schmitt Triggered Logic Inputs with Internal Pull Down
- Undervoltage Lockout for High and Low Side Drivers
- Extended Temperature Range: -40°C to +125°C
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony free. "Green" Device (Note 3)

### **Mechanical Data**

- Case: SO-8
- Case Material: Molded Plastic. "Green" Molding Compound.
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 <sup>(3)</sup>
- Weight: 0.075 grams (Approximate)



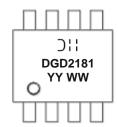
### Ordering Information (Note 4)

| Part number  | Marking | Reel size (inches) | Tape width (mm) | Quantity per reel |
|--------------|---------|--------------------|-----------------|-------------------|
| DGD2181S8-13 | DGD2181 | 13                 | 12              | 2,500             |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

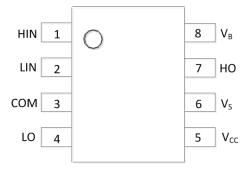
## **Marking Information**



Oll = Manufacturer's Marking
DGD2181 = Product Type Marking Code
YY = Year (ex: 15 = 2015)
WW = Week (01 - 53)



## **Pin Diagrams**

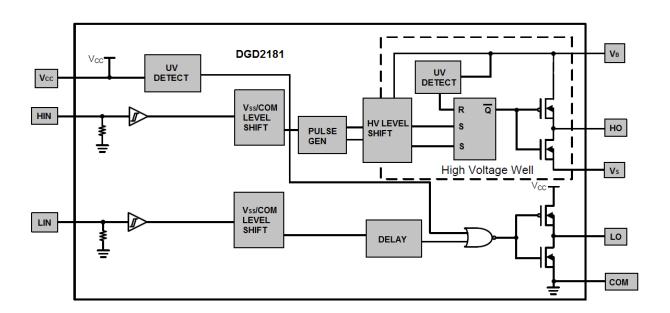


Top View SO-8

# **Pin Descriptions**

| Pin Number | Pin Name       | Function   |
|------------|----------------|--|
| 1          | HIN            | Logic input for high-side gate driver output, in phase with HO |
| 2          | LIN            | Logic input for low-side gate driver output, in phase with LO  |
| 3          | COM            | Low-side and logic return                                      |
| 4          | LO             | Low-side gate drive output                                     |
| 5          | Vcc            | Low-side and logic fixed supply                                |
| 6          | Vs             | High-side floating supply return                               |
| 7          | НО             | High-side gate drive output                                    |
| 8          | V <sub>B</sub> | High-side floating supply                                      |

# **Functional Block Diagram**





# **Absolute Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                           | Symbol               | Value                        | Unit |
|--|----------------------|------------------------------|------|
| High-side Floating Supply Voltage        | V <sub>B</sub>       | -0.3 to +624                 | V    |
| High-side Floating Supply Offset Voltage | Vs                   | $V_B$ -24 to $V_B$ +0.3      | V    |
| High-side Floating Output Voltage        | V <sub>HO</sub>      | $V_S$ -0.3 to $V_B$ +0.3     | V    |
| Offset Supply Voltage Transient          | dV <sub>S</sub> / dt | 50                           | V/ns |
| Low-side Fixed Supply Voltage            | V <sub>CC</sub>      | -0.3 to +24                  | V    |
| Low-side Output Voltage                  | $V_{LO}$             | -0.3 to V <sub>CC</sub> +0.3 | V    |
| Logic Input Voltage (HIN and LIN)        | V <sub>IN</sub>      | -0.3 to V <sub>CC</sub> +0.3 | V    |

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                                    | Symbol           | Value       | Unit |
|---|------------------|-------------|------|
| Power Dissipation Linear Derating Factor (Note 5) | $P_{D}$          | 0.625       | W    |
| Thermal Resistance, Junction to Ambient (Note 5)  | $R_{\theta JA}$  | 200         | °C/W |
| Operating Temperature                             | TJ               | +150        |      |
| Lead Temperature (Soldering, 10s)                 | $T_L$            | +300        | °C   |
| Storage Temperature Range                         | T <sub>STG</sub> | -55 to +150 |      |

Note: 5. When mounted on a standard JEDEC 2-layer FR-4 board.

# **Recommended Operating Conditions**

| Parameter                                  | Symbol          | Min                 | Max                 | Unit |
|--|-----------------|---------------------|---------------------|------|
| High side Floating Supply Absolute Voltage | $V_{B}$         | V <sub>S</sub> + 10 | V <sub>S</sub> + 20 | V    |
| High side Floating Supply Offset Voltage   | Vs              | (Note 6)            | 600                 | V    |
| High side Floating Output Voltage          | V <sub>HO</sub> | Vs                  | V <sub>B</sub>      | V    |
| Low Side Fixed Supply Voltage              | Vcc             | 10                  | 20                  | V    |
| Low Side Output Voltage                    | $V_{LO}$        | 0                   | Vcc                 | V    |
| Logic Input Voltage (HIN and LIN)          | V <sub>IN</sub> | 0                   | 5                   | V    |
| Ambient Temperature                        | T <sub>A</sub>  | -40                 | +125                | °C   |

Note: 6. Logic operation for V<sub>S</sub> of -5V to +600V. Logic state held for V<sub>S</sub> of -5V to -V<sub>BS</sub>.



# $\textbf{DC Electrical Characteristics} \ (V_{BIAS} \ (V_{CC}, V_{BS}) = 15V, \ @T_A = +25^{\circ}C, \ unless \ otherwise \ specified.) \ (Note \ 7)$

| Parameter   | Symbol              | Min | Тур | Max | Unit | Conditions                      |
|---|---------------------|-----|-----|-----|------|---------------------------------|
| Logic "1" Input Voltage                                       | $V_{IH}$            | 2.5 | -   | -   | V    | V <sub>CC</sub> = 10V to 20V    |
| Logic "0" Input Voltage                                       | $V_{IL}$            | 1   | -   | 0.8 | V    | $V_{CC} = 10V$ to $20V$         |
| High Level Output Voltage, V <sub>BIAS</sub> - V <sub>O</sub> | VoH                 | _   | -   | 1.4 | V    | $I_O = 0mA$                     |
| Low Level Output Voltage, V <sub>O</sub>                      | $V_{OL}$            | -   | -   | 0.2 | V    | $I_O = 20mA$                    |
| Offset Supply Leakage Current                                 | I <sub>LK</sub>     | 1   | -   | 50  | μΑ   | $V_B = V_S = 600V$              |
| Quiescent V <sub>BS</sub> Supply Current                      | I <sub>BSQ</sub>    | 20  | 60  | 150 | μΑ   | V <sub>IN</sub> = 0V or 5V      |
| Quiescent V <sub>CC</sub> Supply Current                      | Iccq                | 50  | 120 | 240 | uA   | $V_{IN} = 0V \text{ or } 5V$    |
| Logic "1" Input Bias Current                                  | I <sub>IN+</sub>    | _   | 25  | 60  | μΑ   | $V_{IN} = 5V$                   |
| Logic "0" Input Bias Current                                  | I <sub>IN-</sub>    | 1   | -   | 5.0 | μΑ   | $V_{IN} = 0V$                   |
| V <sub>BS</sub> Supply Under-voltage Positive Going Threshold | V <sub>BSUV+</sub>  | 8.0 | 8.9 | 9.8 | V    | _                               |
| V <sub>BS</sub> Supply Under-voltage Negative Going Threshold | V <sub>BSUV</sub> - | 7.4 | 8.2 | 9.0 | V    | _                               |
| V <sub>CC</sub> Supply Under-voltage Positive Going Threshold | V <sub>CCUV+</sub>  | 8.0 | 8.9 | 9.8 | V    | _                               |
| V <sub>CC</sub> Supply Under-voltage Negative Going Threshold | V <sub>CCUV</sub> - | 7.4 | 8.2 | 9.0 | V    | _                               |
| Output High Short Circuit Pulsed Current                      | I <sub>O+</sub>     | 1.4 | 1.9 | _   | Α    | V <sub>O</sub> = 0V, PW ≤ 10µs  |
| Output Low Short Circuit Pulsed Current                       | I <sub>O-</sub>     | 1.7 | 2.3 | -   | Α    | V <sub>O</sub> = 15V, PW ≤ 10μs |

Note: 7. The V<sub>IN</sub> and I<sub>IN</sub> parameters are applicable to the two logic input pins: LIN and HIN. The V<sub>O</sub> and I<sub>O</sub> parameters are applicable to the respective output pins: HO and LO.

# AC Electrical Characteristics ( $V_{BIAS}$ ( $V_{CC}$ , $V_{BS}$ ) = 15V, $C_L$ = 1000pF, @ $T_A$ = +25°C, unless otherwise specified.)

| Parameter                           | Symbol          | Min | Тур | Max | Unit | Conditions                  |
|-------------------------------------|-----------------|-----|-----|-----|------|-----------------------------|
| Turn-on Propagation Delay           | t <sub>ON</sub> | _   | 180 | 270 | ns   | $V_S = 0V$                  |
| Turn-off Propagation Delay          | toff            | _   | 220 | 330 | ns   | V <sub>S</sub> = 0V or 600V |
| Delay Matching, HS & LS Turn-on/off | t <sub>DM</sub> | _   | _   | 35  | ns   | _                           |
| Turn-on Rise Time                   | t <sub>r</sub>  | _   | 40  | 60  | ns   | $V_S = 0V$                  |
| Turn-off Fall Time                  | t <sub>f</sub>  | -   | 20  | 35  | ns   | $V_S = 0V$                  |



# **Timing Waveforms**

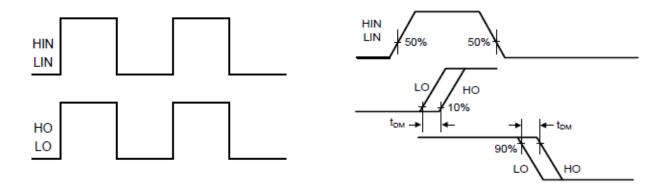


Figure 1. Input / Output Timing Diagram

Figure 2. Delay Matching Waveform Definitions

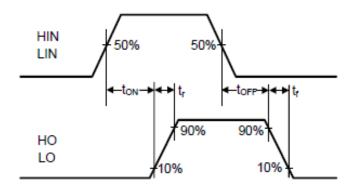


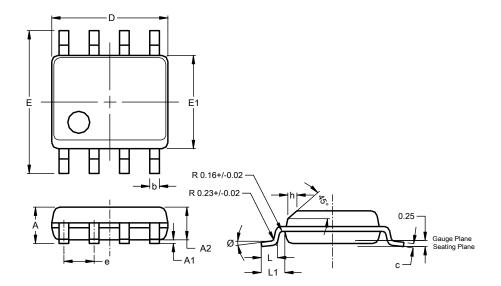
Figure 3. Switching Time Waveform Definitions



# **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

### SO-8 (Type TH)

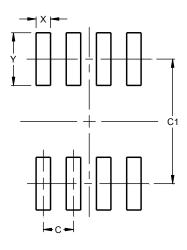


| ;                    | SO-8 (Type TH) |       |      |  |  |  |  |
|----------------------|----------------|-------|------|--|--|--|--|
| Dim                  | Min            | Max   | Тур  |  |  |  |  |
| Α                    | 1.35           | 1.75  | 1    |  |  |  |  |
| A1                   | 0.10           | 0.25  | 1    |  |  |  |  |
| A2                   |                |       | 1.45 |  |  |  |  |
| b                    | 0.35           | 0.51  |      |  |  |  |  |
| С                    | 0.190          | 0.248 |      |  |  |  |  |
| D                    | 4.80           | 5.00  | 4.90 |  |  |  |  |
| Е                    | 5.80           | 6.20  | 6.00 |  |  |  |  |
| E1                   | 3.80           | 4.00  | 3.90 |  |  |  |  |
| е                    |                |       | 1.27 |  |  |  |  |
| h                    | 0.25           | 0.50  | -    |  |  |  |  |
| L                    | 0.41           | 1.27  |      |  |  |  |  |
| L1                   |                |       | 1.04 |  |  |  |  |
| Ø                    | 0°             | 8°    |      |  |  |  |  |
| All Dimensions in mm |                |       |      |  |  |  |  |

## **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

### SO-8 (Type TH)



| <b>Dimensions</b> | Value (in mm) |
|-------------------|---------------|
| С                 | 1.27          |
| C1                | 5.20          |
| Х                 | 0.60          |
| Υ                 | 2.20          |

Note: For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device Terminals and PCB tracking.



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